



## PS-2769

### Product Description:

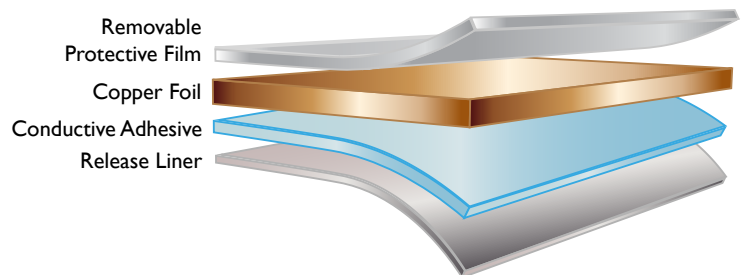
P-SHIELD® PS-2769 is an electrodeposited copper foil which has been coated with an electrically conductive adhesive on one side. A removable polyester protective film has been laminated to the copper to reduce surface oxidation. This copper allows for electrical conductivity in the x, y and z-direction.

### Construction / Properties:

Property	Value	Test Method
Total Thickness	0.05mm +/- 0.005mm	QSP-726
Foil Type	Electrodeposited Copper	--
Color	Copper	--
Adhesive Peel Strength (to SUS)	1000 g/25mm	QSP-722
Surface Resistivity	<0.2 Ω/sq	QSP-741
Z-Axis Resistance	<0.2 Ω/in <sup>2</sup>	QSP-741
Shielding Effectiveness (30 MHz - 1.5 GHz)	80 - 100 dB	ASTM D4935
Recommended Application Specification	2 kg/square inch pressure for 2 seconds	--
Continuous Use Conditions	15 - 70 C	QSP-754

### Features:

- Superior Converting Properties
- Excellent Conformability
- Good Shielding Effectiveness
- RoHS and HF Compliant



Specific tests should be performed by the end user to determine the product stability for the particular application.

### For Additional Information:

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Revision: 031424